

ABSTRACT OF THE DISCLOSURE

An electrolytic processing apparatus according to an embodiment of the present invention includes: a substrate 5 holder for holding a substrate; a first electrode to make contact with the substrate for passing electricity to a processing surface of the substrate; an electrode head including high resistance structure and a second electrode, disposed opposite to and in this order from the substrate holder, and a polishing surface facing processing surface of the substrate held by the substrate holder; an electrolytic solution injection portion injecting an electrolytic solution between the processing surface of the substrate held by the substrate holder and the second electrode; a relative movement mechanism for moving the substrate holder and the electrode head relative to each other; a press mechanism for pressing the polishing surface of the electrode head against the substrate held by the substrate holder; and a power source for applying a voltage between the first electrode and second electrode. The power source is capable of selectively switching the direction of electric current.

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